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**Product data sheet** 

## 1. Product profile

### 1.1 General description

The BB179 is a planar technology variable capacitance diode, in a SOD523 (SC-79) ultra small plastic SMD package. The excellent matching performance is achieved by gliding matching and a Direct Matching Assembly (DMA) procedure.

#### 1.2 Features and benefits

- Excellent linearity
- Excellent matching to 2 % DMA
- Ultra small plastic SMD package
- C<sub>d(28V)</sub>: 2.1 pF; C<sub>d(1V)</sub> to C<sub>d(28V)</sub> ratio: 9
- Low series resistance.

### 1.3 Applications

- Electronic tuning in UHF television tuners
- Voltage Controlled Oscillators (VCO).

# 2. Pinning information

Table 1. Pinning

Pin	Description	Simplified outline[1]	Symbol
1	cathode		11
2	anode	1 2	+
			sym008

<sup>[1]</sup> The marking bar indicates the cathode.

# 3. Ordering information

Table 2. Ordering information

Type number	Package				
	Name	Description	Version		
BB179	SC-79	plastic surface mounted package; 2 leads	SOD523		



### **UHF** variable capacitance diode

# 4. Marking

Table 3. Marking

Type number	Marking code
BB179	9

# 5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

		• • •	,		
Symbol	Parameter	Conditions	Min	Max	Unit
$V_{R}$	reverse voltage		-	30	V
$V_{RM}$	peak reverse voltage	in series with a $10 \text{ k}\Omega$ resistor	-	35	V
l <sub>F</sub>	forward current		-	20	mA
T <sub>stg</sub>	storage temperature		-55	+150	°C
Tj	junction temperature		-55	+125	°C

## 6. Characteristics

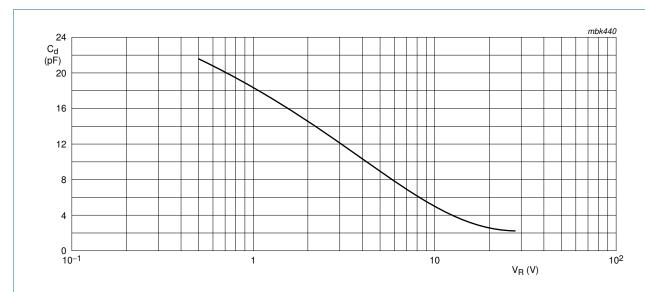
Table 5. Characteristics

 $T_i = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$I_R$	reverse current	see Figure 2				
		$V_R = 30 \text{ V}$	-	-	10	nA
		$V_R = 30 \text{ V}; T_j = 85 ^{\circ}\text{C}$	-	-	200	nA
r <sub>s</sub>	diode series resistance	f = 470 MHz	<u>[1]</u> _	0.6	0.75	Ω
C <sub>d</sub>	diode	f = 1  MHz; see Figure 1 and 3				
	capacitance	$V_R = 1 V$	18.22	! -	21.26	pF
		$V_{R} = 28 \text{ V}$	1.951	2.1	2.225	pF
$\frac{C_{d(1V)}}{C_{d(2V)}}$	capacitance ratio	f = 1 MHz	-	1.27	-	
$\frac{C_{d(1V)}}{C_{d(28V)}}$	capacitance ratio	f = 1 MHz	8.45	9	10.9	
$\frac{C_{d(25V)}}{C_{d(28V)}}$	capacitance ratio	f = 1 MHz	-	1.05	-	
$\frac{\Delta C_d}{C_d}$	capacitance matching	$V_R = 1 \text{ V to } 28 \text{ V; in a}$ sequence of 10 diodes (gliding)	-	-	2	%

<sup>[1]</sup>  $V_R$  is the value at which  $C_d = 9 pF$ 

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f = 1 MHz;  $T_j = 25 \,^{\circ}\text{C}$ .

Fig 1. Diode capacitance as a function of reverse voltage; typical values.

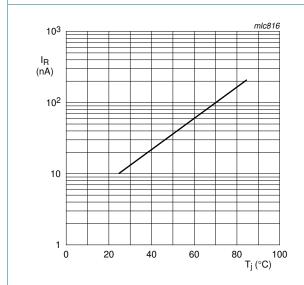
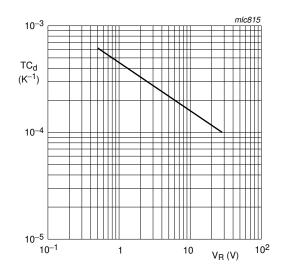


Fig 2. Reverse current as a function of junction temperature; maximum values.



 $T_i = 0$  °C to 85 °C.

Fig 3. Temperature coefficient of diode capacitance as a function of reverse voltage; typical values.

### **UHF** variable capacitance diode

# 7. Package outline

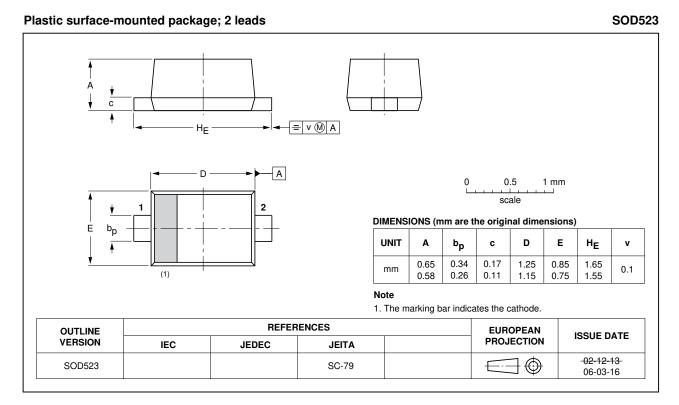


Fig 4. Package outline SOD523 (SC-79).

# UHF variable capacitance diode

# 8. Revision history

### Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BB179 v.3	20110905	Product data sheet	-	BB179 v.2
Modifications:		of this data sheet has been of NXP Semiconductors.	redesigned to comply v	vith the new identity
	etvat lana I	have been adapted to the n	ew company name who	are appropriate
	Legal lexis	have been adapted to the h	ew company name who	ne appropriate.
	ū	utline drawings have been u		• • •
BB179 v.2 (9397 750 13832)	ū	•		• • •

#### **UHF** variable capacitance diode

## 9. Legal information

#### 9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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BB179

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